



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





	IAD170P	Units
Load Voltage	350	V
Load Current	100	mA
Max R _{ON}	50	Ω

Description

The IAD170P multifunction switch combines 350V, 100mA, 50Ω relay(s) and optocoupler(s) into a single package. Various combinations are available depending on the part number. This switch provides an ideal way to consolidate functionality into a single package.

Features

- Three Functions in One Package
- Small 16 Pin SOIC Package (PCMCIA Compatible)
- Bi-Directional Current Sensing
- Bi-Directional Current Switching
- Replaces up to Three or Four Components
- 3750V_{RMS} Input/Output Isolation
- FCC Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hookswitch
 - Dial Pulsing
 - Ground Start
 - Ringer Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

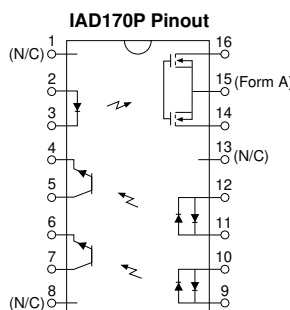
Approvals

- Tape & Reel Versions Available
- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-12
- VDE Compatible
- BSI Certified:
 - BS EN 60950:1992 (BS7002:1992)
Certificate #:7969
 - BS EN 41003:1993
Certificate #:7969

Ordering Information

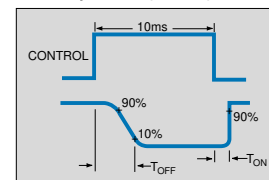
Part #	Description
IAD170P	16 Pin SOIC (50/Tube)
IAD170PTR	16 Pin SOIC (1000/Reel)

Pin Configuration

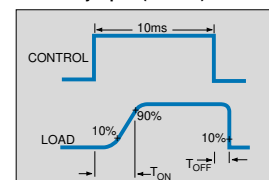


1. (N/C)
2. + LED - Relay Input
3. - LED - Relay Input
4. Emitter - Phototransistor #1
5. Collector - Phototransistor #1
6. Emitter - Phototransistor #2
7. Collector - Phototransistor #2
8. (N/C)
9. LED - Phototransistor +/- #2
10. LED - Phototransistor +/- #2
11. LED - Phototransistor +/- #1
12. LED - Phototransistor +/- #1
13. (N/C)
14. Output - Relay
15. Common - Relay
16. Output - Relay

Switching Characteristics of Normally Closed (Form B) Devices



Switching Characteristics of Normally Open (Form A) Devices



Absolute Maximum Ratings (@ 25° C)

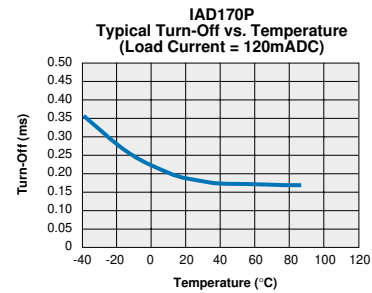
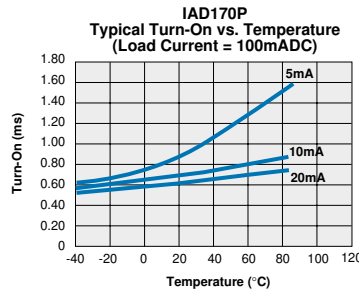
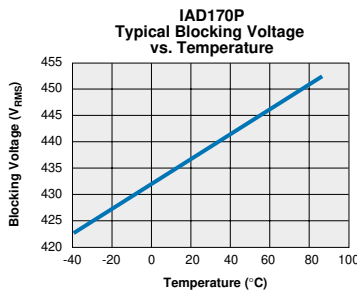
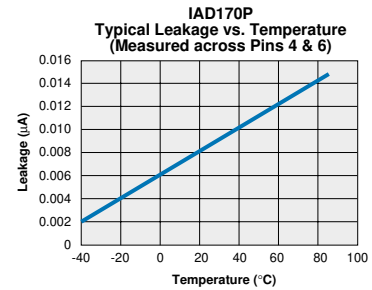
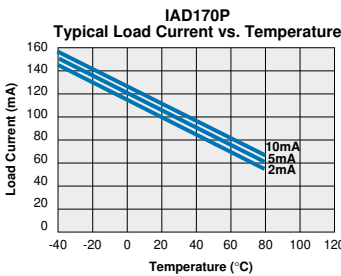
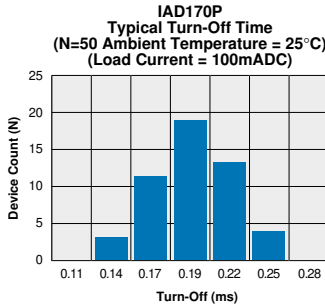
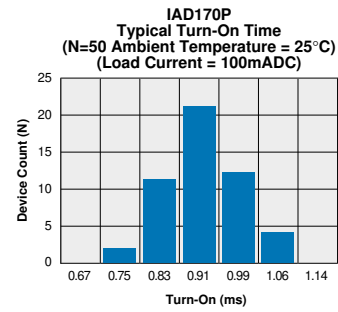
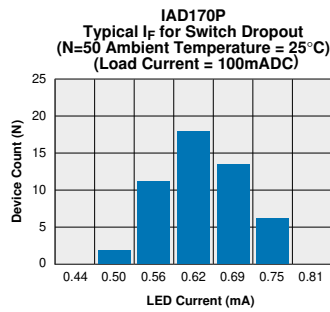
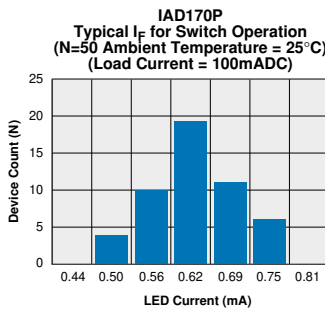
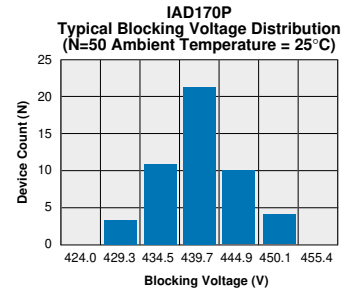
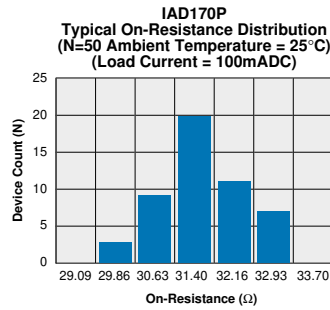
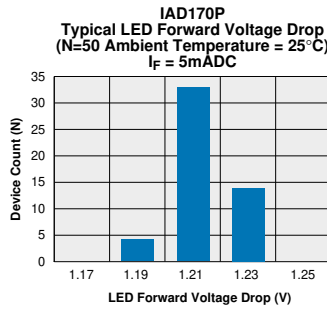
Parameter	Min	Typ	Max	Units
Total Package Dissipation	-	-	1 ¹	W
Isolation Voltage Input to Output	3750	-	-	V _{RMS}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature (10 Seconds Max.)	-	-	+220	°C

¹ Above 25° derate linearly 1.67mw/°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

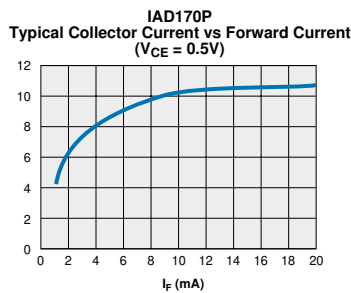
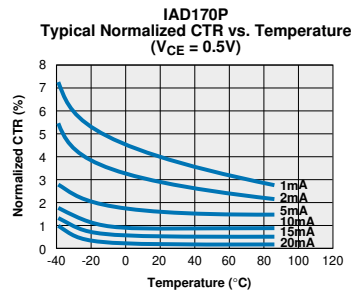
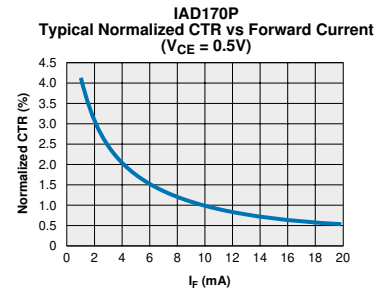
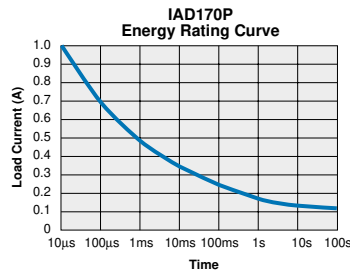
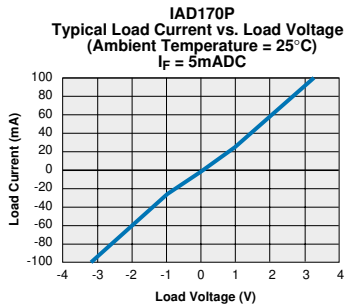
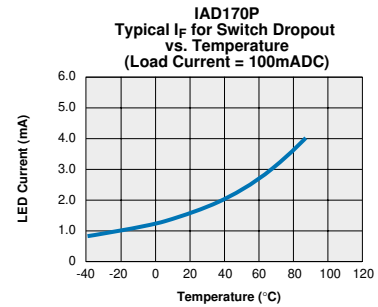
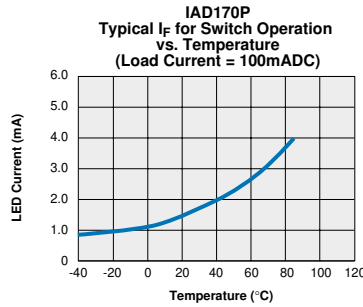
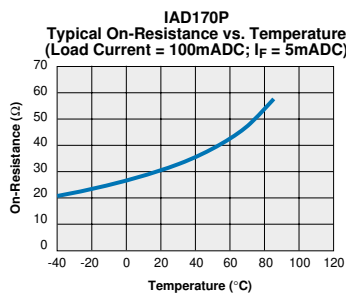
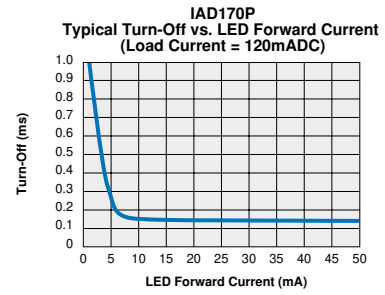
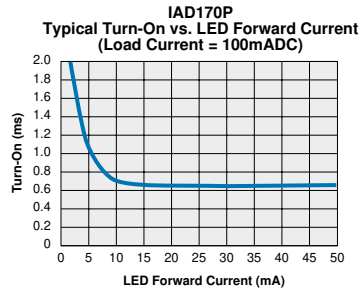
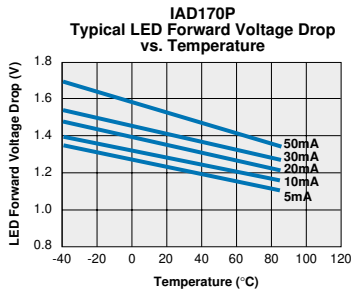
Electrical Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Relay Portion						
Output Characteristics @ 25° C						
Load Voltage (Peak)	-	V _L	-	-	350	V
Load Current (Continuous)	-	I _L	-	-	100	mA
Peak Load Current	10ms	I _{LPK}	-	-	350	mA
On-Resistance	I _L =100mA	R _{ON}	-	-	50	Ω
Off-State Leakage Current	V _L =350V; T _J =25° C	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	5	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	5	ms
Output Capacitance	V _L =50V, f=1MHz	-	-	25	-	pF
Relay Portion						
Input Characteristics @ 25° C						
Input Control Current	I _L =100mA	I _F	5	-	50	mA
Input Dropout Current	I _L =1mA	I _F	0.4	-	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V _R	-	-	5	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Detector Portion						
Output Characteristics @ 25° C						
Phototransistor Blocking Voltage	I _C =10μA	B _{VCEO}	20	50	-	V
Phototransistor Dark Current	V _{CE} =5V, I _F =0mA	I _{CEO}	-	50	500	nA
Saturation Voltage	I _C =2mA, I _F =16mA	V _{SAT}	-	0.3	0.5	V
Current Transfer Ratio	I _F =6mA, V _{CE} =0.5V	C _{TR}	33	-	-	%
Detector Portion						
Input Characteristics @ 25° C						
Input Control Current	I _C =2mA, V _{CE} =0.5V	I _F	6	2	-	mA
Input Voltage Drop	I _F =5mA	I _{CEO}	0.9	1.2	1.4	V
Input Current (Detector must be off)	I _C =1μA, V _{CE} =5V	-	5	25	-	μA
Input to Output Capacitance	V _L =50V, f=1MHz	C _{I/O}	-	3	-	pF
Input to Output Isolation	-	V _{I/O}	3750	-	-	V _{RMS}

PERFORMANCE DATA*


The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

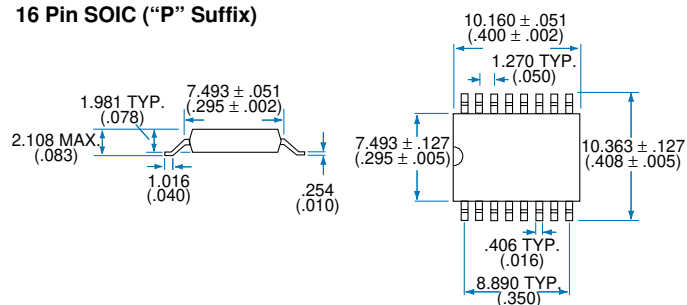
PERFORMANCE DATA*



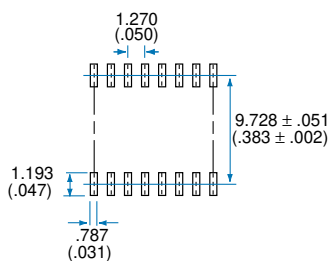
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Mechanical Dimensions

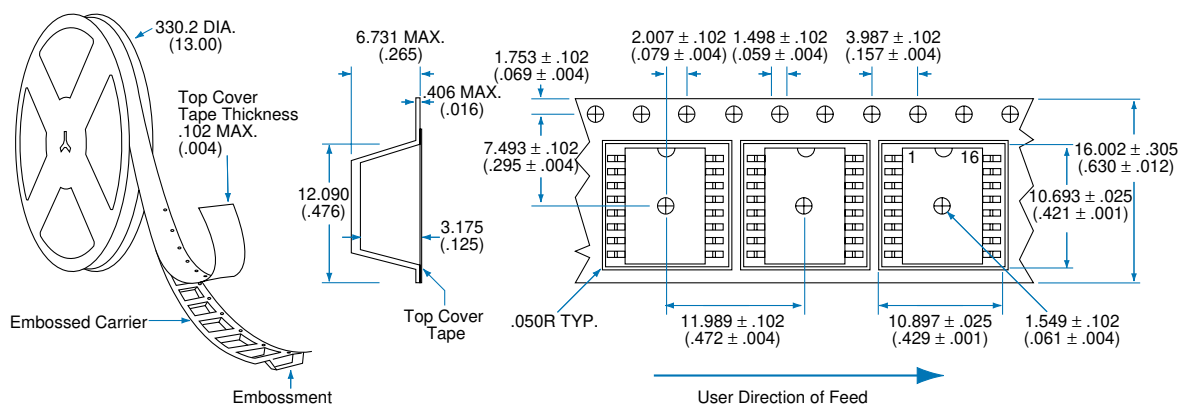
16 Pin SOIC ("P" Suffix)



PC Board Pattern (Top View)



Tape and Reel Packaging for 16 Pin SOIC Package



Dimensions
 mm
 (inches)



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